

# Development Highlights of Taiwan's Semiconductor Industry, 2Q 2023 (pre-order)

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## Abstracts

The overall shipment value of Taiwan's semiconductor industry in the first quarter of 2023 reached US\$29.3 billion, representing a decline of 13.7% compared to 4Q 2022 and a decline of 22.4% compared to 1Q 2022. This report aims to analyze key development trends and issues in the IC design, semiconductor manufacturing, and packaging and testing industry sectors in the first quarter of 2023, as well as the development highlights of Taiwan's semiconductor industry as a whole; examines the development of the semiconductor industry in the second quarter of 2023 and beyond.

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